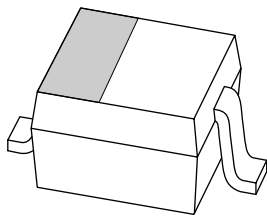


# DATA SHEET



**BAP51-03**

General purpose PIN diode

Product specification  
Supersedes data of 1999 Aug 16

2004 Feb 11

# General purpose PIN diode

# BAP51-03

## FEATURES

- Low diode capacitance
- Low diode forward resistance.

## APPLICATIONS

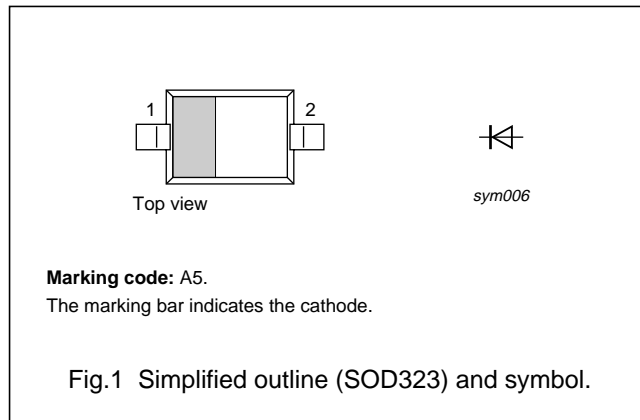
- General RF applications.

## DESCRIPTION

General purpose PIN diode in a SOD323 small plastic SMD package.

## PINNING

PIN	DESCRIPTION
1	cathode
2	anode



## ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
BAP51-03	-	plastic surface mounted package; 2 leads	SOD323

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_R$	continuous reverse voltage		-	50	V
$I_F$	continuous forward current		-	50	mA
$P_{tot}$	total power dissipation	$T_S = 90\text{ °C}$	-	500	mW
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature		-65	+150	°C

## General purpose PIN diode

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**ELECTRICAL CHARACTERISTICS** $T_j = 25\text{ °C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_F$	forward voltage	$I_F = 50\text{ mA}$	–	0.95	1.1	V
$V_R$	reverse voltage	$I_R = 10\text{ }\mu\text{A}$	50	–	–	V
$I_R$	reverse current	$V_R = 50\text{ V}$	–	–	100	nA
$C_d$	diode capacitance	$V_R = 0; f = 1\text{ MHz}$	–	0.4	–	pF
		$V_R = 1\text{ V}; f = 1\text{ MHz}$	–	0.3	0.55	pF
		$V_R = 5\text{ V}; f = 1\text{ MHz}$	–	0.2	0.35	pF
$r_D$	diode forward resistance	$I_F = 0.5\text{ mA}; f = 100\text{ MHz}; \text{note 1}$	–	5.5	9	$\Omega$
		$I_F = 1\text{ mA}; f = 100\text{ MHz}; \text{note 1}$	–	3.6	6.5	$\Omega$
		$I_F = 10\text{ mA}; f = 100\text{ MHz}; \text{note 1}$	–	1.5	2.5	$\Omega$
$\tau_L$	charge carrier life time	when switched from $I_F = 10\text{ mA}$ to $I_R = 6\text{ mA}; R_L = 100\text{ }\Omega$ ; measured at $I_R = 3\text{ mA}$	–	550	–	ns

**Note**

1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

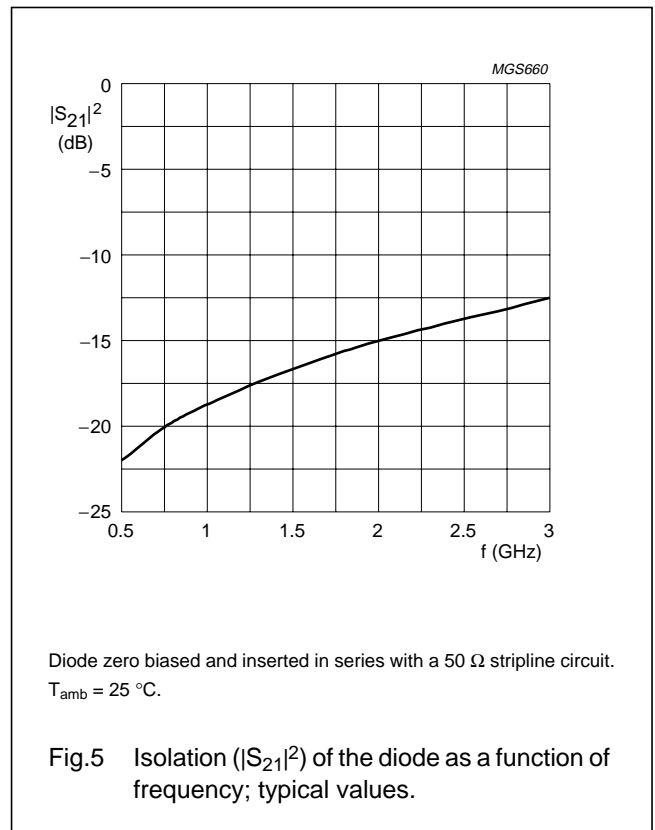
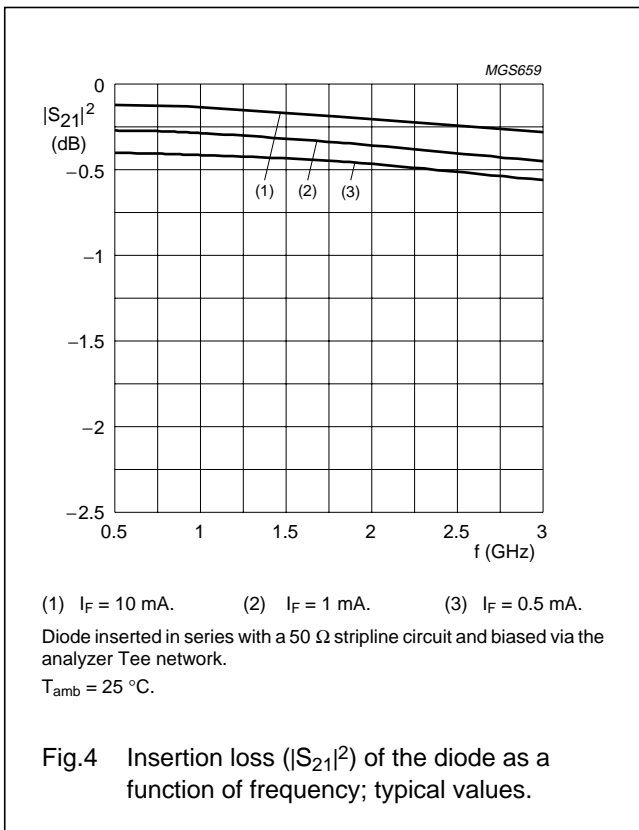
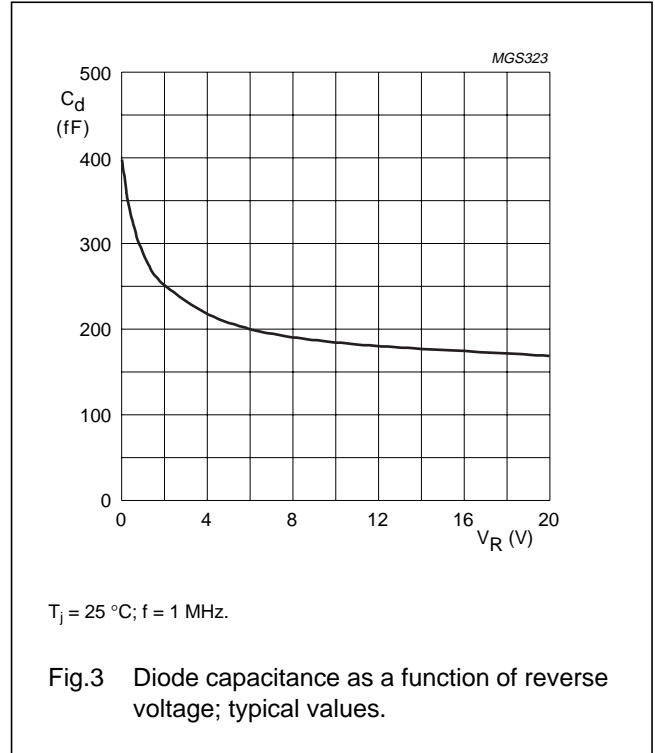
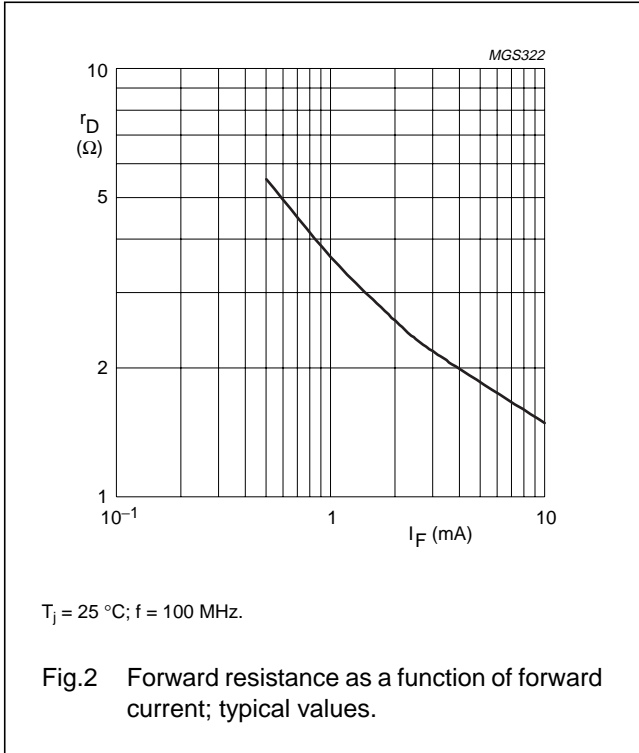
**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th(j-s)}$	thermal resistance from junction to soldering point	120	K/W

General purpose PIN diode

BAP51-03

GRAPHICAL DATA



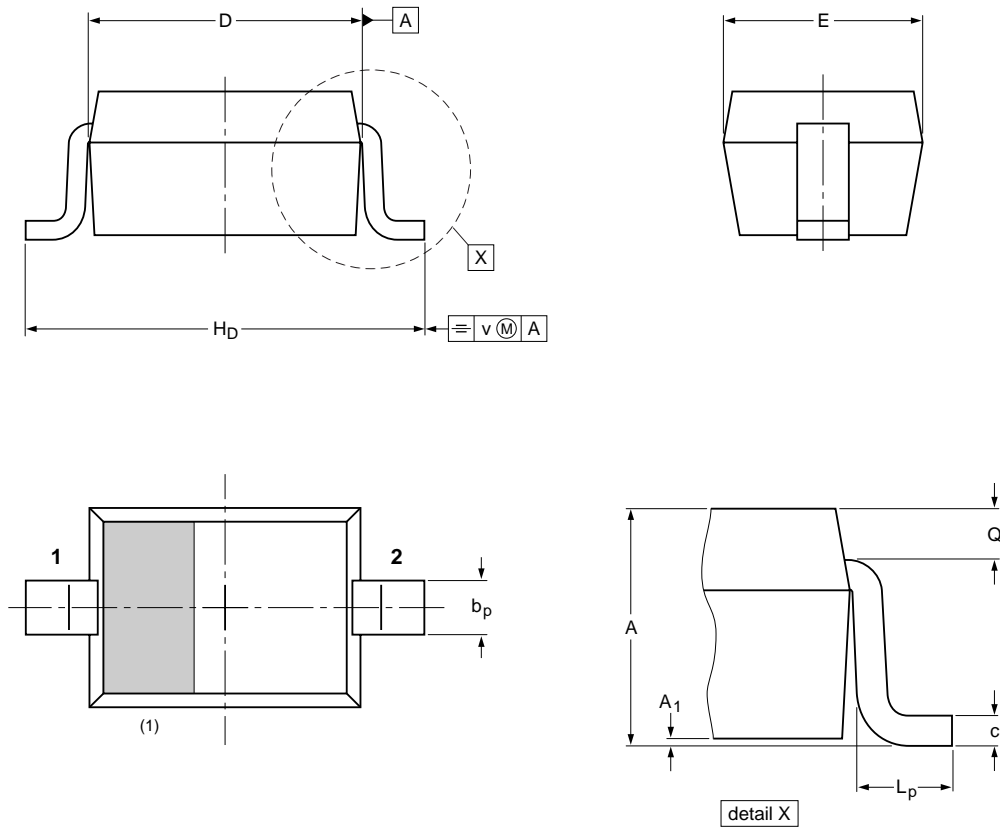
General purpose PIN diode

BAP51-03

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD323



DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub> max	b <sub>p</sub>	c	D	E	H <sub>D</sub>	L <sub>p</sub>	Q	v
mm	1.1 0.8	0.05	0.40 0.25	0.25 0.10	1.8 1.6	1.35 1.15	2.7 2.3	0.45 0.15	0.25 0.15	0.2

Note

1. The marking bar indicates the cathode

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOD323			SC-76		99-09-13 03-12-17

## General purpose PIN diode

BAP51-03

## DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

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3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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